PCB Number: TIDA_00628
PCB Rev: E1

DANGER HIGH VOLTAGE

CAUTION HOT SURFACE

Assembly Note ZZ1
This Assembly Note is for PCB labels only

Assembly Note ZZ2
These assemblies are ESD sensitive. ESD precautions shall be observed.

Assembly Note ZZ3
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note ZZ4
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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